TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

# 2SC5092

### VHF~UHF Band Low Noise Amplifier Applications

• Low noise figure, high gain.

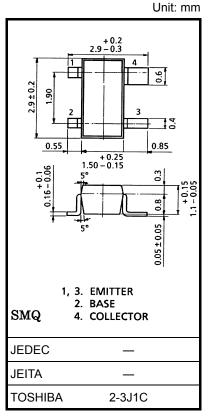
• NF = 1.8dB,  $|S_{21e}|^2 = 9.5dB$  (f = 2 GHz)

### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	$V_{CBO}$	20	V	
Collector-emitter voltage	$V_{CEO}$	10	V	
Emitter-base voltage	V <sub>EBO</sub>	1.5	V	
Base current	ΙΒ	20	mA	
Collector current	IC	40	mA	
Collector power dissipation	PC	150	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	-55~125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 0.012 g (typ.)

### Microwave Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit		
Transition frequency	f <sub>T</sub>	$V_{CE} = 8 \text{ V}, I_{C} = 20 \text{ mA}$	7	10	_	GHz		
Insertion gain	S <sub>21e</sub>   <sup>2</sup> (1)	V <sub>CE</sub> = 8 V, I <sub>C</sub> = 20 mA, f = 1 GHz	1 GHz 12 15 —		dB			
insertion gain	S <sub>21e</sub>   <sup>2</sup> (2)	$V_{CE} = 8 \text{ V}, I_{C} = 20 \text{ mA}, f = 2 \text{ GHz}$	6.5	9.5	_	ub l		
Noise figure	NF (1)	$V_{CE} = 8 \text{ V}, I_{C} = 5 \text{ mA}, f = 1 \text{ GHz}$	_	1.4	2.5	dB		
Noise ligure	NF (2)	$V_{CE} = 8 \text{ V}, I_{C} = 5 \text{ mA}, f = 2 \text{ GHz}$	_	1.8	3	ub		

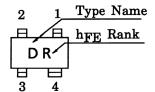
### **Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0$	_	_	1	μА
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = 1 \text{ V, } I_{C} = 0$	_	_	1	μА
DC current gain	h <sub>FE</sub> (Note 1)	V <sub>CE</sub> = 8 V, I <sub>C</sub> = 20 mA	50	_	160	
Output capacitance	C <sub>ob</sub>	V <sub>CB</sub> = 10 V, I <sub>F</sub> = 0, f = 1 MHz (Note 2)	_	0.7	1.1	pF
Reverse transfer capacitance	C <sub>re</sub>	$V_{CB} = V_{CB} + V_{CB} = V_{CB} + V_{CB} = V_{CB} + V_{CB} + V_{CB} = V_{CB} + V$		0.45	0.95	pF

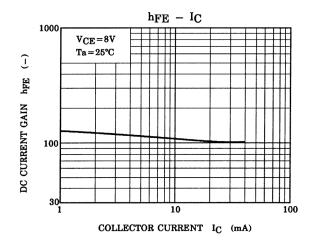
Note 1: hFE classification R: 50~100, O: 80~160

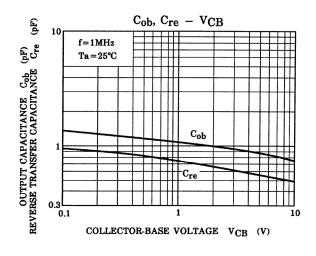
Note 2:  $C_{re}$  is measured by 3 terminal method with capacitance bridge.

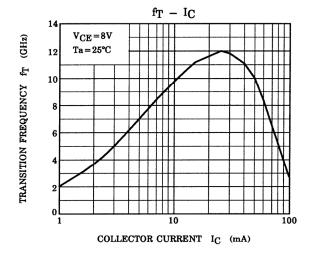
# Marking

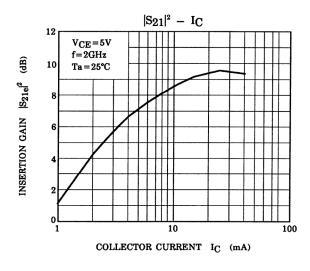


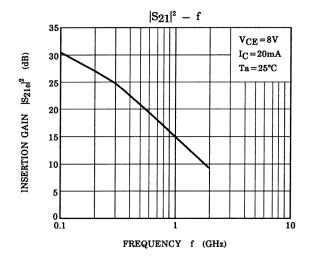
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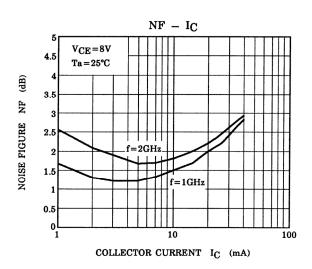




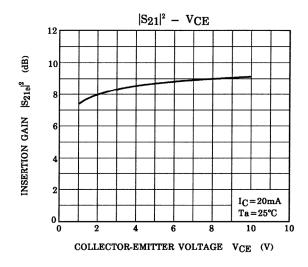


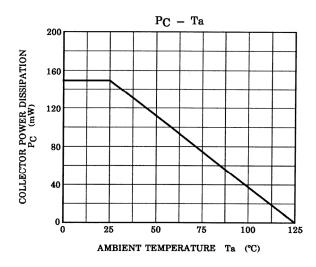






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## S-Parameter $Z_O = 50 \Omega$ , $Ta = 25^{\circ}C$

### $V_{CE} = 8 V, I_C = 5 mA$

Frequency	y S11		S21		S12		S22	
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.767	-58.9	12.888	143.5	0.049	62.8	0.856	-34.5
400	0.655	-102.2	9.480	119.3	0.073	48.7	0.663	-57.5
600	0.605	-130.0	7.087	104.6	0.086	43.1	0.535	-72.7
800	0.567	-150.4	5.577	93.9	0.093	40.7	0.456	-84.3
1000	0.547	-166.4	4.548	86.0	0.098	41.1	0.407	-93.8
1200	0.533	-179.7	3.798	79.3	0.103	42.5	0.373	-102.4
1400	0.528	169.1	3.268	76.9	0.109	44.1	0.346	-110.3
1600	0.519	158.4	2.856	69.3	0.116	46.6	0.328	-117.4
1800	0.520	148.3	2.551	65.1	0.124	48.9	0.314	-123.0
2000	0.524	138.7	2.290	61.1	0.133	51.1	0.303	-128.3

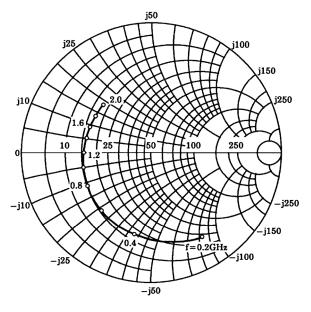
### $V_{CE} = 8 V$ , $I_C = 20 mA$

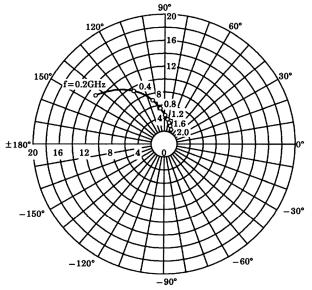
Frequency	S	11	S2	21	S1	12	S	22
(MHz)	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.	Mag.	Ang.
200	0.540	-106.8	23.009	123.0	0.033	56.9	0.605	-57.8
400	0.521	-147.5	13.445	102.7	0.045	54.9	0.392	-81.2
600	0.521	-167.1	9.277	92.8	0.057	57.9	0.309	-95.5
800	0.525	-178.9	7.029	85.7	0.069	60.0	0.271	-107.3
1000	0.526	-168.8	5.651	80.0	0.082	62.5	0.250	-117.9
1200	0.529	-158.7	4.688	75.6	0.094	63.4	0.236	-127.6
1400	0.531	-148.5	4.011	71.6	0.106	64.5	0.225	-136.2
1600	0.536	-140.4	3.531	68.1	0.119	65.1	0.214	-143.8
1800	0.539	-131.7	3.159	64.7	0.133	65.5	0.201	-149.8
2000	0.540	-122.8	2.842	61.8	0.147	65.7	0.190	-154.8

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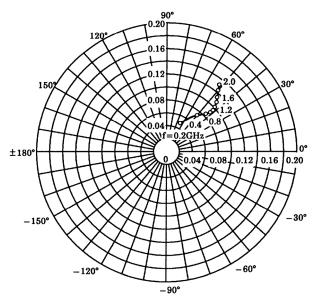
 $\begin{array}{l} S_{11e} \\ V_{CE} = 8V \\ I_{C} = 5mA \\ Ta = 25^{\circ}C \\ (Unit: \Omega) \end{array}$ 

 $S_{21e}$   $V_{CE}=8V$   $I_{C}=5mA$   $T_{a}=25^{\circ}C$ 





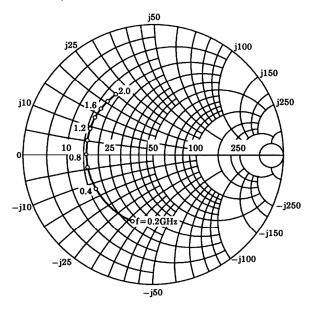
S<sub>12e</sub> V<sub>CE</sub>=8V I<sub>C</sub>=5mA Ta=25°C

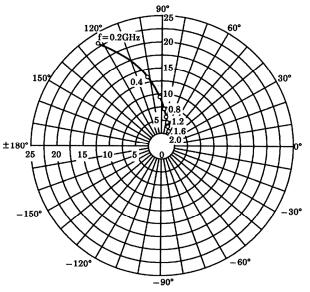


 $\begin{array}{c} S22e \\ VCE = 8V \\ IC = 5mA \\ Ta = 25^{\circ}C \\ (Unit:\Omega) \\ & j50 \\ & j100 \\ & j25 \\ & j100 \\ & j250 \\ & j250 \\ & j100 \\ & j250 \\ & j250$ 

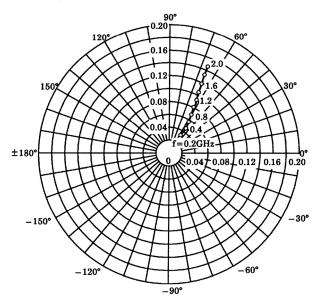
 $\begin{array}{l} \text{S}_{11e} \\ \text{V}_{\text{CE}} = 8\text{V} \\ \text{I}_{\text{C}} = 20\text{mA} \\ \text{Ta} = 25^{\circ}\text{C} \\ \text{(Unit: } \Omega\text{)} \end{array}$ 

 $\begin{array}{l} S_{21e} \\ V_{CE} = 8V \\ I_{C} = 20 \text{mA} \\ T_{a} = 25 ^{\circ}\text{C} \end{array}$ 

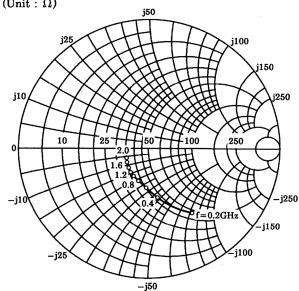




 $\begin{array}{l} S_{12e} \\ V_{CE} = 8V \\ I_{C} = 20 \text{mA} \\ T_{a} = 25 ^{\circ}\text{C} \end{array}$ 



 $S_{22e}$   $V_{CE}=8V$   $I_{C}=20mA$   $T_{a}=25^{\circ}C$   $(Unit: \Omega)$ 



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